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DOCUMENT : SKN40000NH

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1/2W, 0612, LF Type Low Resistance Chip Resistor (Lead / Halogen Free)

1. Scope

This specification applies to 1.6mm x 3.2mm size 1/2W.

2. Type Designation

Where

(2)

(3)

(1) Series No.

(2) 4F = 1/2W

(3) Resistance value :

For example -

 $1R5m = 1.5m\Omega$

 $R005 = 5m\Omega$

(4) Resistance value:

$$F = \pm 1\%$$

$$G = \pm 2\%$$

$$J = \pm 5\%$$

(5) NH = Sn plating (Lead free / Halogen free)

Outline Designation

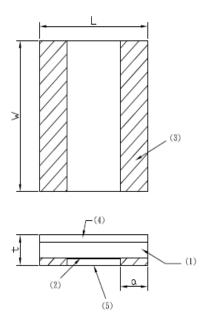


Figure 1. Construction and Dimensions

(1) Substrate

(2) Resistor

Cu-alloy

(3) Terminals

Sn (on Cu)

(4) Marking

Heat resistive epoxy resin

(5) Protection coat

Heat resistive epoxy resin

Code Letter	Dimensions (mm)		
L	1.6 ± 0.20		
W	3.2 ± 0.25		
a	0.35 ± 0.20		
t	$2 \sim 10 \text{ m}\Omega$	0.5 ± 0.20	
	1 mΩ, 1.5 mΩ	0.7 ± 0.20	

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4. Ratings

4-1 Specification

Power Ratings *	1/2 W				
Resistance Value	$1~\text{m}\Omega,1.5~\text{m}\Omega$	$2~\mathrm{m}\Omega,2.5~\mathrm{m}\Omega$	$3 \text{ m}\Omega \sim 10 \text{ m}\Omega$		
Temperature Coefficient of Resistance (Reflow)	±200ppm/°C	±150ppm/°C	±100ppm/°C		
Resistance Tolerance	±1%, ±2%, ±5%				

Note *:

Power ratings is based on continuous full load operation at rated ambient temperature of 70° C. For resistors operated at ambient temperature in excess of 70° C, the maximum load shall be derated in accordance with the following curve.

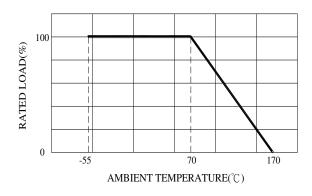


Figure 2. : Power Temperature Derating Curve

4-2 Rated Voltage

The rated voltage shall be determined by the following expression.

 $V = \sqrt{P \times R}$ Where V: Rated voltage (V)

R: Nominal resistance value (Ω)

P: Rated dissipation (W)

4-3 Operating and Storage Temperature Range

-55 to $+170^{\circ}$ C

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5. Life test

Test Item	Condition of Test	Requirements	
Short Time Overload	2.5 * rated power for 5 seconds Refer to JIS C 5201-1 4.13	$\Delta R:\pm 1.0\%$	
Thermal Shock	-55 ~125°C 100 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	$\Delta R: \pm 1.0\%$	
Low Temperature Storage	Kept at -55°C, 1,000 hours Refer to JIS C 5201-1 4.23.4	$\Delta R: \pm 2.0\%$	
Load Life	Rated voltage for 1.5hours followed by a pause 0.5hour at $70 \pm 3^{\circ}$ C. Cycle repeated 1000 hours Refer to JIS C 5201-1 4.25	ΔR: ± 2.0%	
Damp Heat with Load	40 ± 2°C with relative humidity 90% to 95%. Cycle repeated 1,000 hours Refer to JIS C 5201-1 4.24	$\Delta R: \pm 2.0\%$	
High Temperature Exposure	Kept at 170°C for 1,000 hours Refer to JIS C 5201-1 4.23.2	$\Delta R: \pm 2.0\%$	
Solderability	Temperature of Solder : $245 \pm 5^{\circ}$ C Immersion Duration : 3 ± 0.5 seconds Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed	
Mechanical Shock	100 G's for 6milliseconds. 5 pulses AR : \pm 1.0% Refer to JIS C 5201-1 4.21		
Bending Test	Glass-Epoxy board thickness: 1.6mm Bending width: 2mm Between the fulcrums: 90mm Refer to JIS C 5201-1 4.33	ΔR: ± 1.0%	

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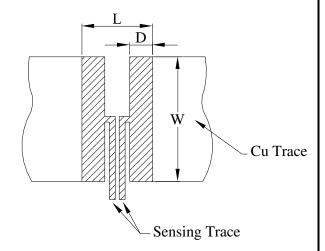
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6. Recommend Land Pattern

	W	L	D	t
	(mm)	(mm)	(mm)	(µm)
1632W LF	3.5	2.4	0.9	105

t: Copper foil minimum thickness of PCB

Note: We recommend there is no circuit design



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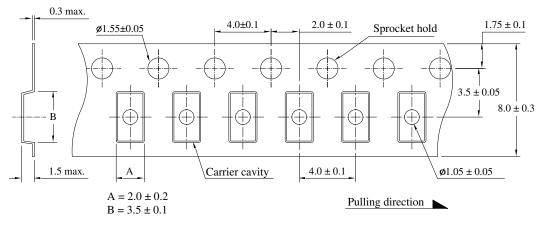
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7. Packaging

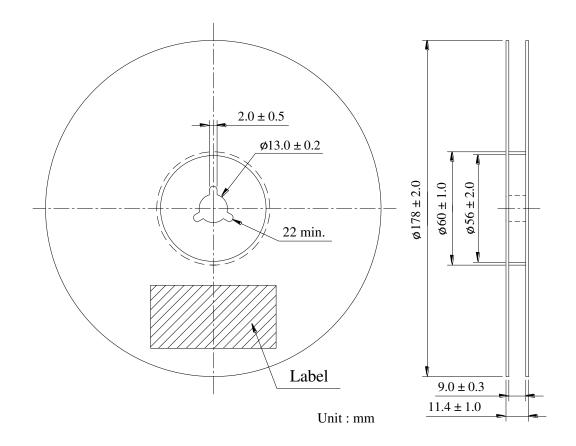
7-1 Dimensions

7-1-1 Tape packaging dimensions



Unit: mm

7-1-2 Reel dimensions



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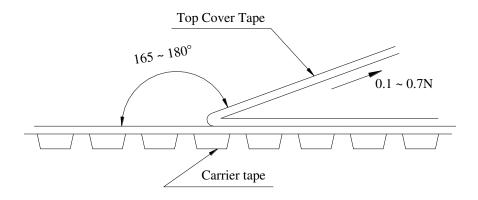
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7-2 Peel Strength of Top Cover Tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall between 0.1 to 0.7N



7-3 Number of Taping

4,000 pieces / reel

7-4 Label marking

The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin